

Customer Information Notification

202401005I : Errata sheet updated for LPC111x products

Note: This notice is NXP Company Proprietary.

Issue Date: Jan 20, 2024 Effective date: Jan 21, 2024

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Errata sheet updated for LPC111x products.

Change Category

[]Wafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[]Wafer Fab Materials	[]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[]Wafer Fab Location	[]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage

[]Firmware [X]Other: Errata sheet update

PCN Overview Description

The errata sheet has been updated for LPC111x products:

The LPC111x errata sheet has been updated to rev 6.1: https://www.nxp.com/docs/en/errata/ES_LPC111X.pdf

Reason

Adding clarification to the ROM.1 errata. Refer to the revision history in the errata sheet.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

See updated errata. **Data Sheet Revision** No impact to existing datasheet **Additional information**

Additional documents: <u>view online</u> **Contact and Support** For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name NXP Tech support

Position NXP Technical Support

e-mail address <u>https://www.nxp.com/support/support:SUPPORTHOME</u>

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NXP Quality Management Team.

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